



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application of:
Yau, et al.

Serial No.: 10/756,122

Confirmation No.: 4554

Filed: January 13, 2004

For: A Low Dielectric Constant
Film Produced From Silicon
Compounds Comprising
Silicon-Carbon Bond

Group Art Unit: 2823

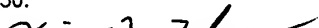
Examiner: Julio J. Maldonado

MAIL STOP AMENDMENT
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

CERTIFICATE OF MAILING
37 CFR 1.8

I hereby certify that this correspondence is being deposited on 3/17, 2006 with the United States Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450 Alexandria, VA 22313-1450.

3/17/06 
Date Keith M. Tackett

RESPONSE TO OFFICE ACTION DATED DECEMBER 22, 2005

In response to the Office Action dated December 22, 2005, having a shortened statutory period for response set to expire on March 22, 2006, please enter this response and reconsider the claims pending in the application for the reasons discussed below. Although Applicants believe that no additional fees are due in connection with this response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/002592.C7/KMT for any fees, including extension of time fees or excess claim fees, required to make this response timely and acceptable to the Office.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper. **Remarks** begin on page 5 of this paper.